

SH Series



Agency Approvals					
AGENCY	AGENCY FILE NUMBER				
9 1	Pending				
7 1	E320116				

Two Electrode GDT Graphical Symbol



Additional Information



Datasheet





Description

The Littelfuse SH Gas Discharge Tubes (GDT) series provides high levels of protection against fast rising transients caused by lightning disturbances. It has a surge rating of 5kA, 8/20µs. Offered in a Squared Surface Mount package, which helps to make pick and place on PCB process easier.

RoHS (Po) 74

This GDT series is perfectly suited for broadband equipment applications. The GDT's low off-state capacitance is compatible with high bandwidth applications and this capacitance loading value does not vary if the voltage across the GDT changes.

The Littelfuse SH Gas Discharge Tube (GDT) series are specifically designed for protection of electrical, multimedia, and communication equipment against over voltage transients in surface mount assembly applications.

Features

- Excellent response to fast rising transients
- GHz working frequency
- 5kA, 8/20µs surge capability as defined by IEC 61000-4-5 2nd Edition
- UL recognized

Applications

- CATV equipment
- Antennas
- RS 485
- Telecom Base Station
- Power Supply AC Main
- G.fast
- EV power Charging
- Inverter/Variable Frequency Drivers (VFDs)

• IEEE 802.3 compliant Ethernet interfaces

• Offered with squared

• Ultra Low capacitance

• Lead-free and RoHS

body package

Non-Radioactive

(<0.7pF)

compliant

- Broad Band equipment
- xDSL, ADSL, ADSL2, VDSL, and VDSL2
- Medical Electronics
- Test Equipment
- General Telecom Equipment
- Renewable Energy



Electrical Characteristics

	Component Specifications (at 25°C)							Life Ratings							
Part	DC	Breakdo in Volts (@100V/s)		Imp Break	mum ulse ·down ·age	Maximum Impulse Discharge Current (8/20µs)	Insulation Resistance	Capaci- tance (@1MHz)	Impulse Discharge Current (8/20µs)	AC Dischage Current (50Hz, 1sec)	AC Dischage Current (9 Cycles @50Hz)	DC Holdover Voltage (<150ms)*	Impulse Life (10/1000µs) (100A)		
Number	MIN	TYP	MAX	@100V/µs	1000V/µs	1 Time	MIN	MAX	MAX	MIN	MIN		MIN		
SH75	60	75	90	600	700		1GΩ					52V			
SH90	72	90	108	600	700	@50V 6kA 1GΩ @100V					52V]			
SH145	116	145	174	600	700		– 6kA						52V		
SH230	186	230	276	600	700						10 Shots @			80V	
SH250	200	250	300	600	700				1GΩ	07.0	(5kA)	_	45 4	135V	300
SH300	240	300	360	650	800			@100V 0.7pf		5A	15A	135V	Shots		
SH350	280	350	420	750	900				1 Shot at 6kA**			135V			
SH400	360	400	480	850	1000				UKA			135V			
SH470	376	470	564	900	1100		1GΩ					150V			
SH600	480	600	720	1000	1200		@250V					150V	1		

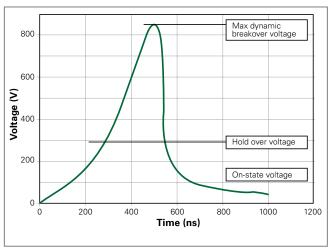
Note:

* Reference REA PE-80, 0.2A, tested to ITU-T Rec K.12 and REA PE 80 <150 ms.

** DC spark-over may exceed ± 25% after discharge, but will continue to protect without venting

Product Characteristics		
Materials	Device Tin Plated 17.5 ± 12.5 Microns Construction: Ceramic Insulator	
Storage and Operational Temperature	-40 to +90°C	

Voltage Vs. Time Characteristic



Note: Tested per 1kV/µs waveform

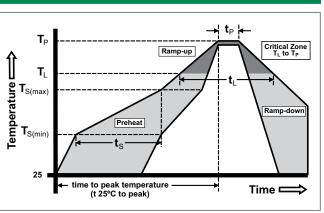
Typical Insertion Loss

@1.0GHz = 0.08dB
@1.4GHz = 0.16dB
@1.8GHz = 0.26dB
@2.0GHz = 0.33dB
@2.4GHz = 0.47dB
@2.8GHz = 0.59dB
@3.1GHz = 0.70dB
@3.5GHz = 0.89dB
@4.0GHz = 1.24dB

Note: Insertion data for customer reference only, application testing needed for verification.

Soldering Parameters - Reflow Soldering (Surface Mount Devices)

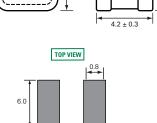
Reflow Co	ndition	Pb – Free assembly		
	-Temperature Min (T _{s(min)})	150°C		
Pre Heat	-Temperature Max (T _{s(max)})	200°C		
	-Time (Min to Max) (t _s)	60 – 180 secs		
Average ra (T _L) to pea	amp up rate (LiquidusTemp k	3°C/second max		
$T_{S(max)}$ to T_L	- Ramp-up Rate	5°C/second max		
Reflow	-Temperature (T _L) (Liquidus)	217°C		
	-Temperature (t _L)	60 – 150 seconds		
PeakTemp	erature (T _P)	260 ^{+0/-5} °C		
Time with Temperatu	in 5°C of actual peak ıre (t _p)	10 – 30 seconds		
Ramp-dov	vn Rate	6°C/second max		
Time 25°C	to peakTemperature (T _P)	8 minutes Max.		
Do not exc	ceed	260°C		



Product Dimensions

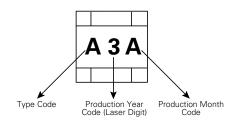
Dimensions in millimeters TOP VIEW (0.5 ± 0.2) (0.5 ± 0.2) (0.5 ± 0.2)

 5.0 ± 0.2



Recommended Soldering Pad Layout

Product Marking



Type Code					
Α	SH75				
В	SH90				
S	SH145				
D	SH230				
R	SH250 SH300				
E					
G	SH350				
I	SH400				
Р	SH470				
V	SH600				

Mo	Month Code				
Α	January				
В	February				
C	March				
D	April				
E	May				
F	June				
G	July				
Н	August				
I	September				
J	October				
К	November				
L	December				



Part Numbering System and Ordering Information

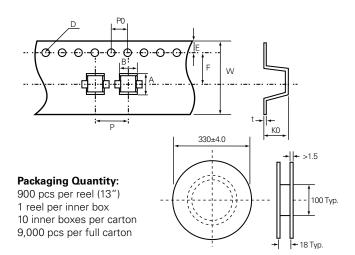
SH XX	(
\top \top \top	_
Series	
Square GDT	
Breakdown Voltage ┘	
75 = 75V	
90 = 90V	
145 = 145V	
230 = 230V	
250 = 250V	
300 = 300V	
350 = 350V	
400 = 400V	
470 = 470V	
600 = 600V	

Taping and Reel Specifications

Taping

Unit = mm

Item	Spec	ltem	Spec
Р	12.0±0.1	D	Ø1.55±0.05
P0	4.0±0.1	W	16.0±0.3
Α	5.4±0.1	K0	5.4±0.1
В	4.6±0.1	t	0.5±0.05



Disclaimer Notice - Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littlefuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at: www.littlefuse.com/disclaimer-electronics.